

SPECIFICATION

DEVICE NAME : Power MOSFET

TYPE NAME : 2SK2833-R

SPEC. No. :

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Fuji Electric Co., Ltd.
Matsumoto Factory

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	DATE	NAME	APPROVED	Fuji Electric Co., Ltd.	
DRAWN				DWG. NO.	1/10
CHECKED					

This specifies Fuji power MOSFET 2SK2833-R

2. Construction N-channel enhancement mode power MOSFET
3. Application for switching
4. Outview T0-3PF Outview See to 4/10 page
5. Absolute maximum ratings at $T_c=25^\circ\text{C}$ (unless otherwise specified)

Description	Symbol	Characteristics	Unit	
Drain-source voltage	V_{DS}	120	V	
Drain-gate voltage	V_{DGR}	120	V	$R_{GS}=20\text{ k}\Omega$
Continuous Drain current	I_D	± 50	A	
Pulsed drain current	I_{DPulse}	± 200	A	
Gate-source voltage	V_{GS}	± 20	V	
Maximum power dissipation	P_D	100	W	
Operating and storage temperature range	T_{ch}	150	$^\circ\text{C}$	
	T_{sto}	$-55 \sim +150$	$^\circ\text{C}$	

6. Electrical characteristics at $T_c=25^\circ\text{C}$ (unless otherwise specified)

Description	Symbol	Conditions	Characteristics			Unit
			Min.	Typ.	Max.	
Drain-source breakdown voltage	BV_{DSS}	$I_D=1\text{mA}$ $V_{GS}=0\text{V}$	120			V
Gate threshold voltage	$V_{GS(th)}$	$I_D=1\text{mA}$ $V_{DS}=V_{GS}$	1.0	1.5	2.5	V
Zero gate voltage drain current	I_{DSS}	$V_{DS}=120\text{V}$ $V_{GS}=0\text{V}$		10	500	μA
	I_{DSS}	$T_{ch}=125^\circ\text{C}$		0.2	1.0	mA
Gate-source leakage current	I_{GSS}	$V_{GS}=\pm 20\text{V}$ $V_{DS}=0\text{V}$		10	100	nA
Drain-source on-state resistance	$R_{DS(on)}$	$I_D=25\text{A}$ $V_{GS}=4\text{V}$		25	45	m Ω
		$V_{GS}=10\text{V}$		20	30	

Dynamic ratings

查询"2SK2833"供应商

Description	Symbol	Conditions	Characteristics			Unit
			Min.	Typ.	Max.	
Forward transconductance	g_{fs}	$I_D = 25A$ $V_{DS} = 25V$	25	50		S
Input capacitance	C_{iss}	$V_{DS} = 25V$ $V_{GS} = 0V$ $f = 1MHz$		5000	7500	pF
Output capacitance	C_{oss}			920	1380	pF
Reverse transfer capacitance	C_{rss}			500	750	pF
Turn-on time	$t_{d(on)}$	$V_{CC} = 60V$ $V_{GS} = 10V$ $I_D = 50A$ $R_{GS} = 25\Omega$		30	45	ns
	t_r			200	300	ns
Turn-off time	$t_{d(off)}$			950	1425	ns
	t_f			400	600	ns

Reverse diode

Description	Symbol	Conditions	Characteristics			Unit
			Min.	Typ.	Max.	
Diode forward on-voltage	V_{SD}	$I_F = 2 \times I_{DR}$ $V_{GS} = 0V, T_{ch} = 25^\circ C$		1.33	2.0	V
Reverse recovery time	t_{rr}	$I_F = I_{DR}$ $V_{GS} = 0V$ $-dI_F/dt = 100A/\mu s$ $T_{ch} = 25^\circ C$		150		ns
Reverse recovery charge	Q_{rr}			1.1		μC

7. Thermal resistance

Description	Symbol	Conditions	Characteristics			Unit
			Min.	Typ.	Max.	
Thermal resistance	$R_{th_{ch-c}}$				1.25	$^\circ C/W$
	$R_{th_{ch-a}}$				30	$^\circ C/W$

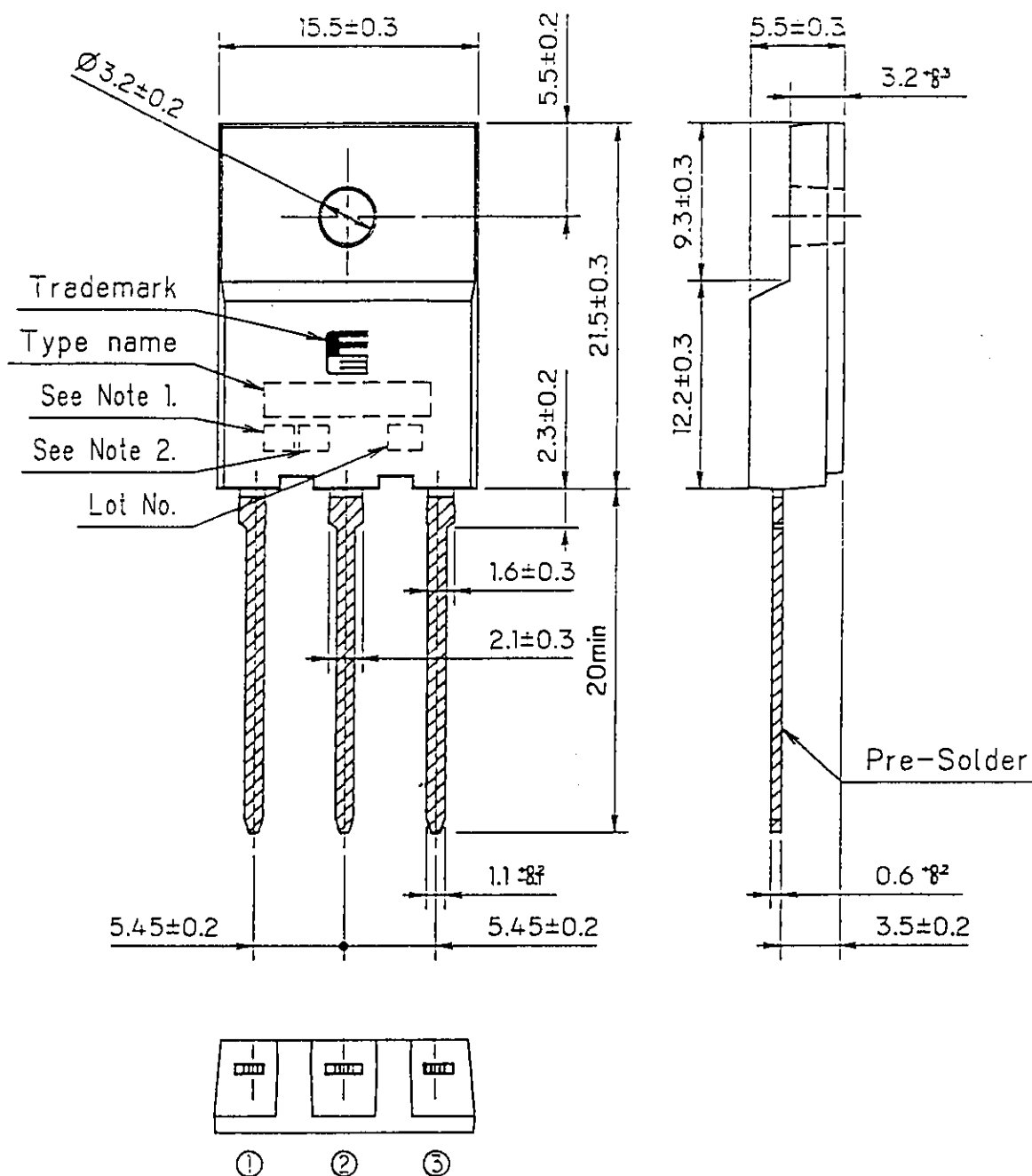
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3/10

H04-004-03

FUJI POWER MOSFET



CONNECTION

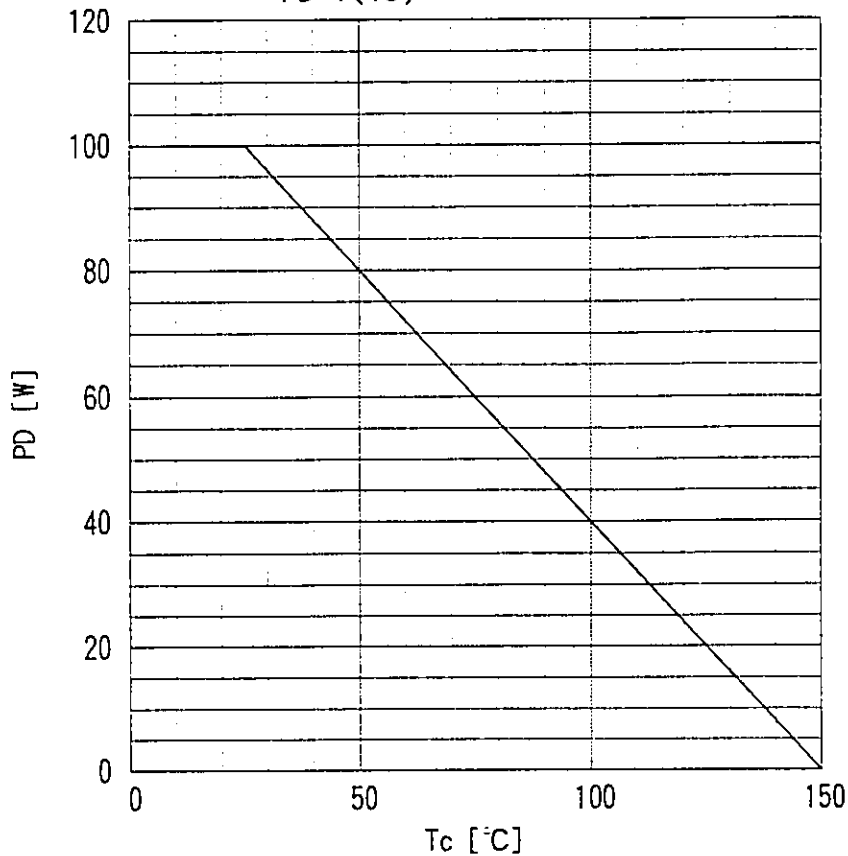
Note 1. Guaranteed mark of avalanche ruggedness.
 2. $V_{GS(th)}$ selected code.

- ① GATE
- ② DRAIN
- ③ SOURCE

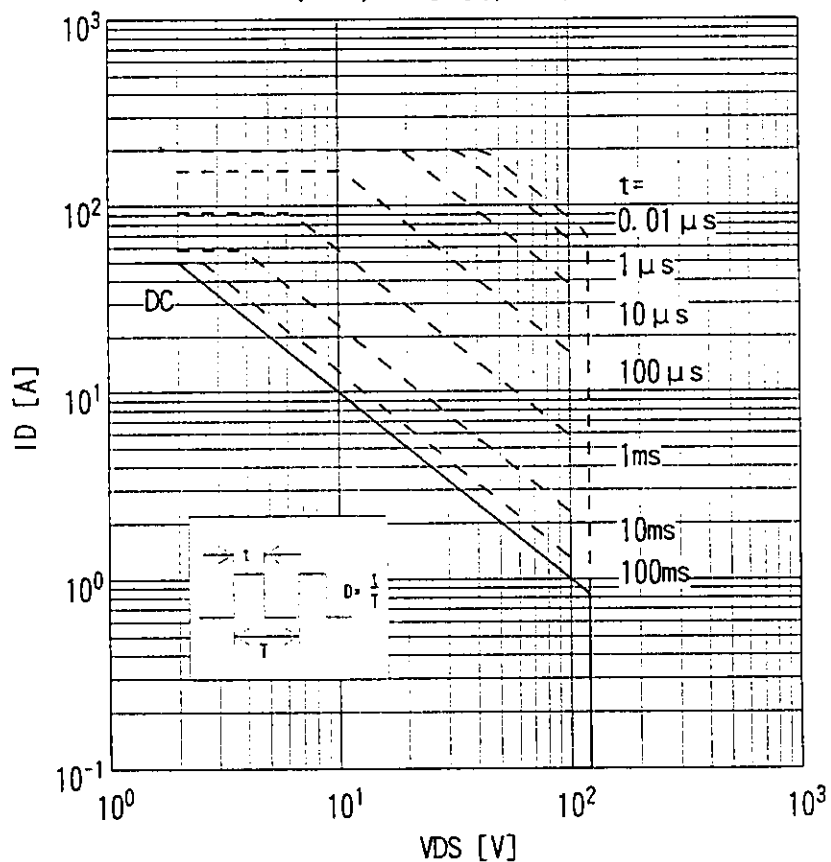
DIMENSIONS ARE IN MILLIMETERS.

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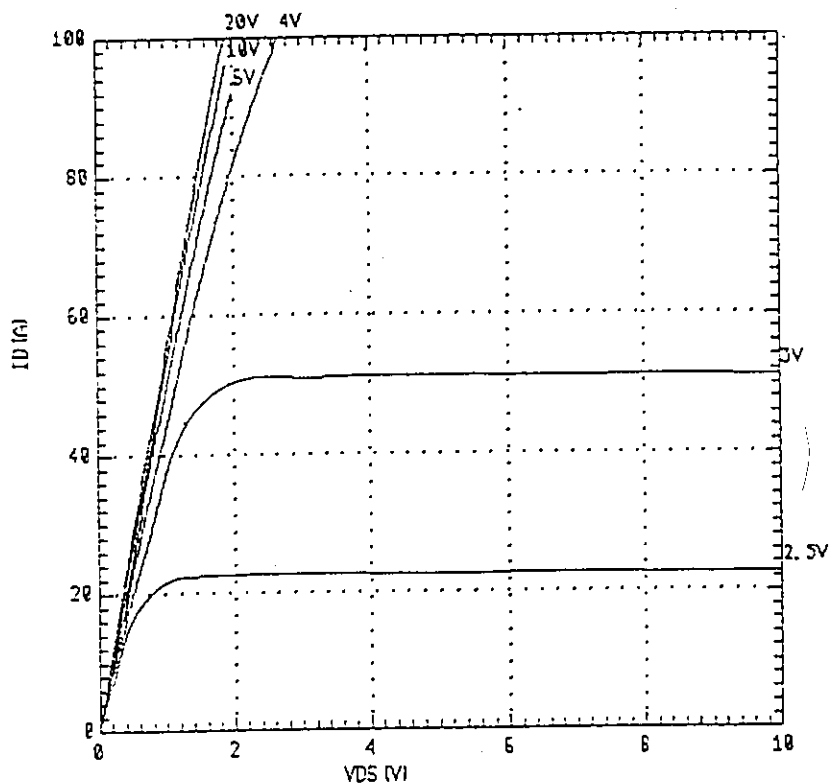
Power Dissipation
 $PD=f(T_c)$



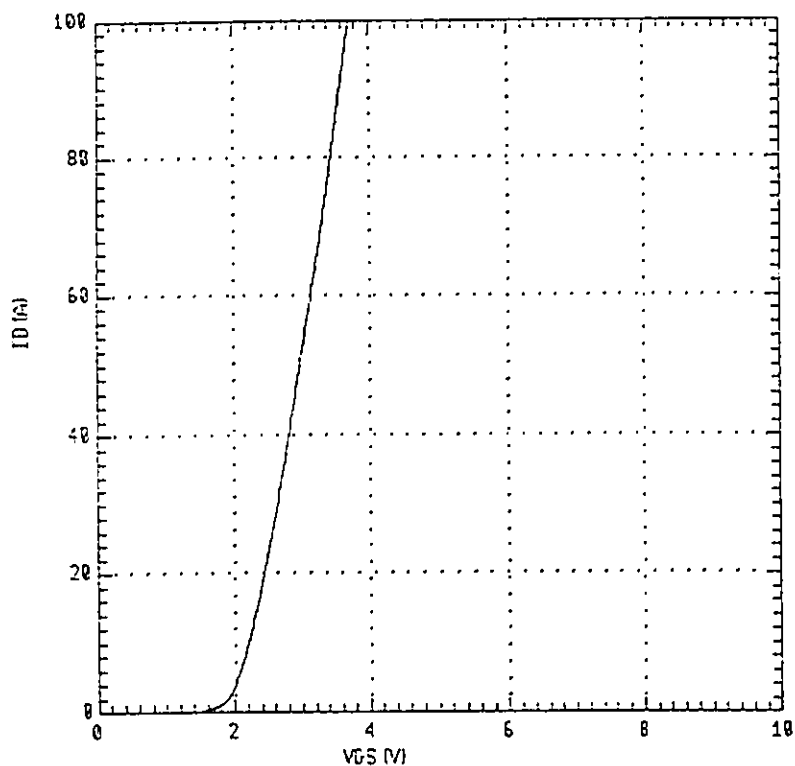
Safe operating area
 $ID=f(V_{DS}):D=0.01, T_c=25^\circ\text{C}$



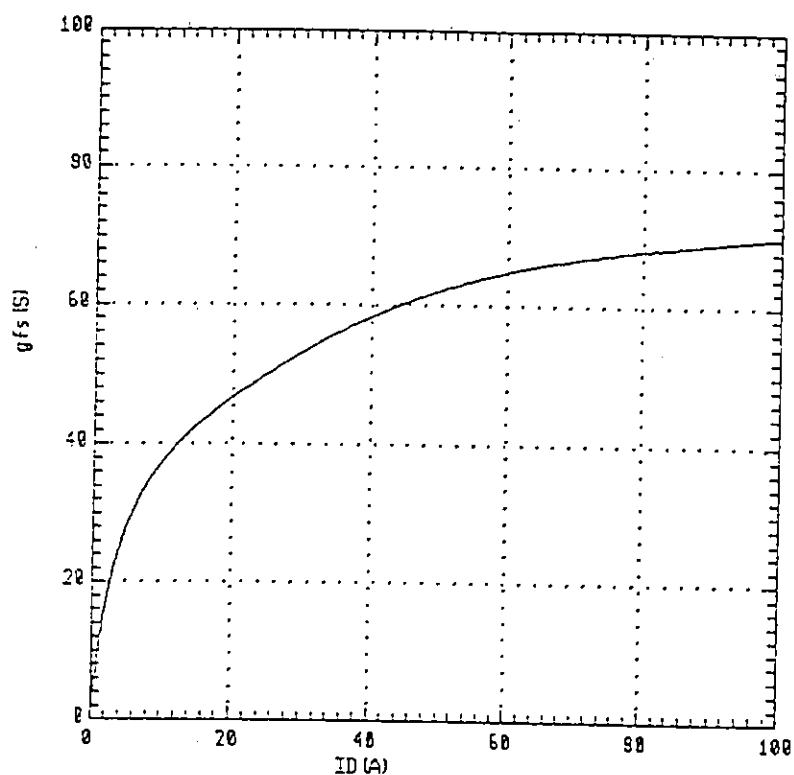
Typical output characteristics
 $I_D = f(V_{DS})$: 80 μ s pulse test, $T_{ch} = 25^\circ\text{C}$



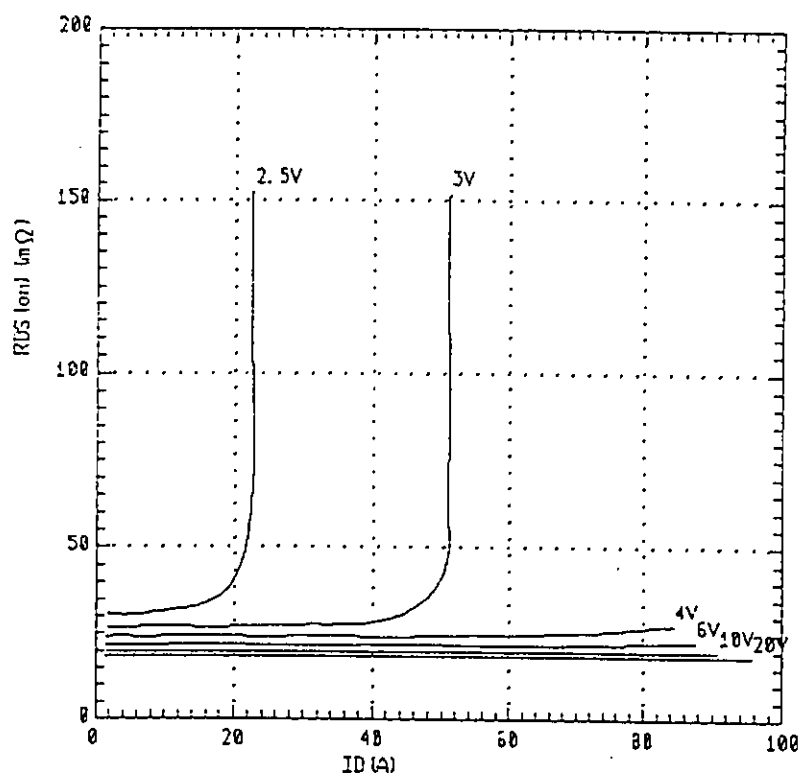
Typical Transfer Characteristic
 $I_D = f(V_{GS})$: 80 μ s pulse test, $V_{DS} = 25\text{V}$



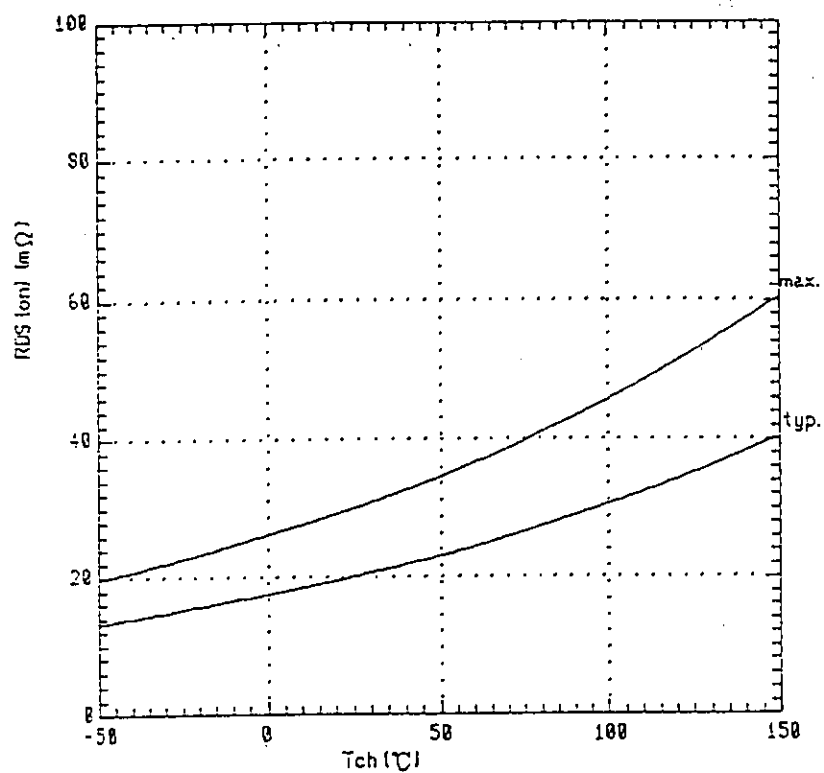
Typical Transconductance
 $g_{fs}=f(I_D):80\mu s$ pulse test, $V_{DS}=25V$, $T_{ch}=25^\circ C$



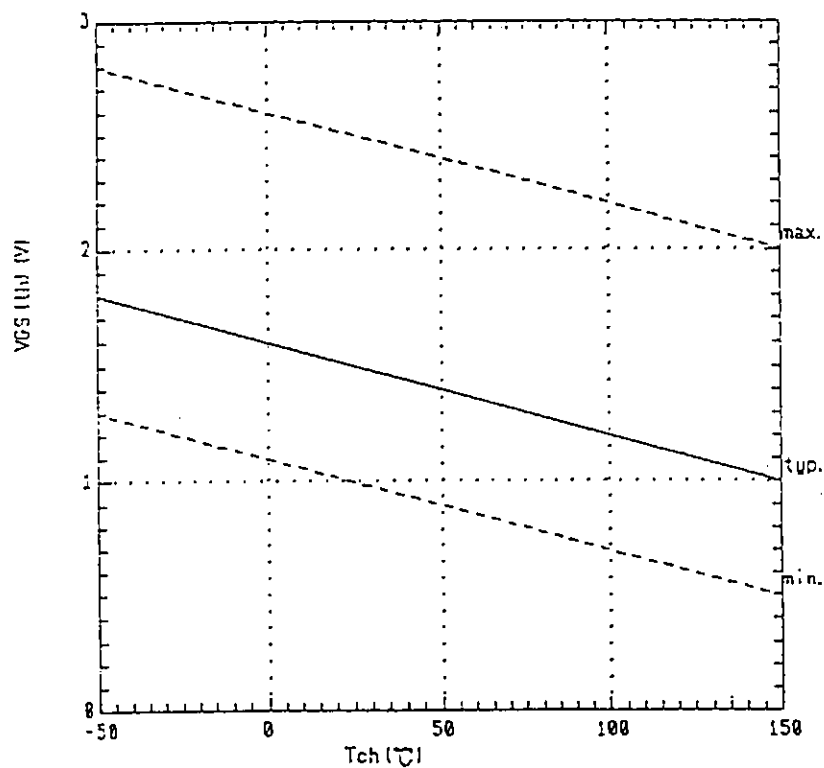
Typical Drain-source on-state resistance
 $R_{DS(on)}=f(I_D):80\mu s$ pulse test, $T_{ch}=25^\circ C$



Drain-source on-state resistance
 $R_{DS(on)} = f(T_{ch}) : I_D = 25A, V_{GS} = 10V$

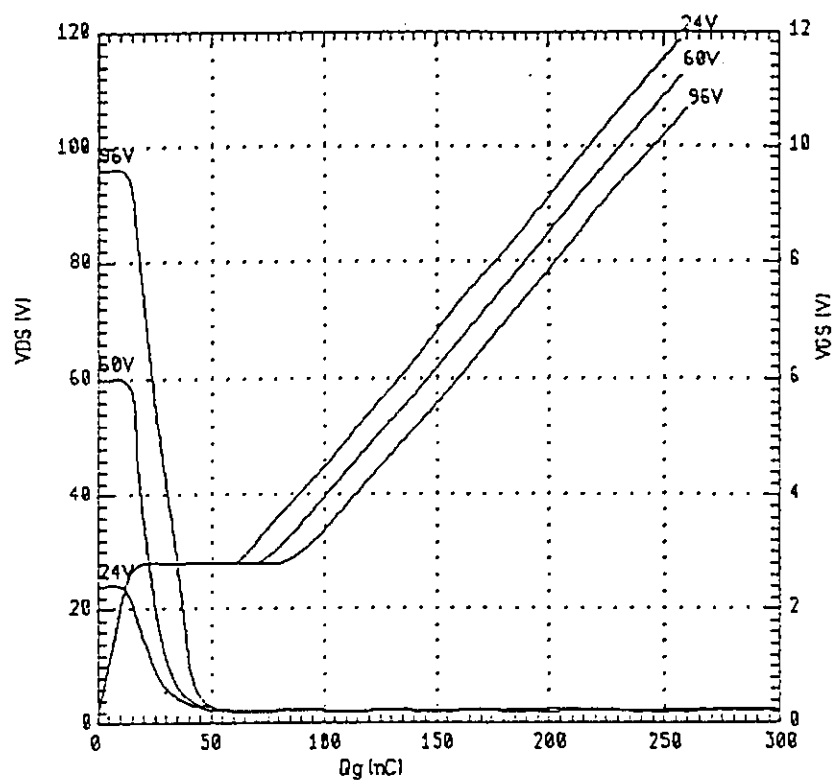


Gate threshold voltage
 $V_{GS(th)} = f(T_{ch}) : V_{DS} = V_{GS}, I_D = 1mA$



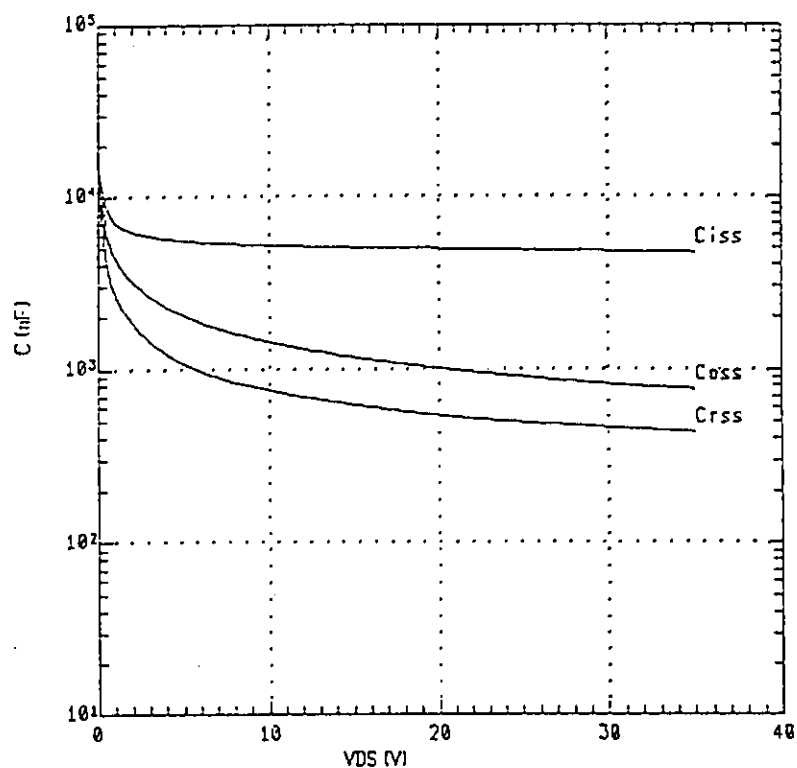
Typical gate charge characteristics

$V_{GS}=f(Q_g): I_D=50A$



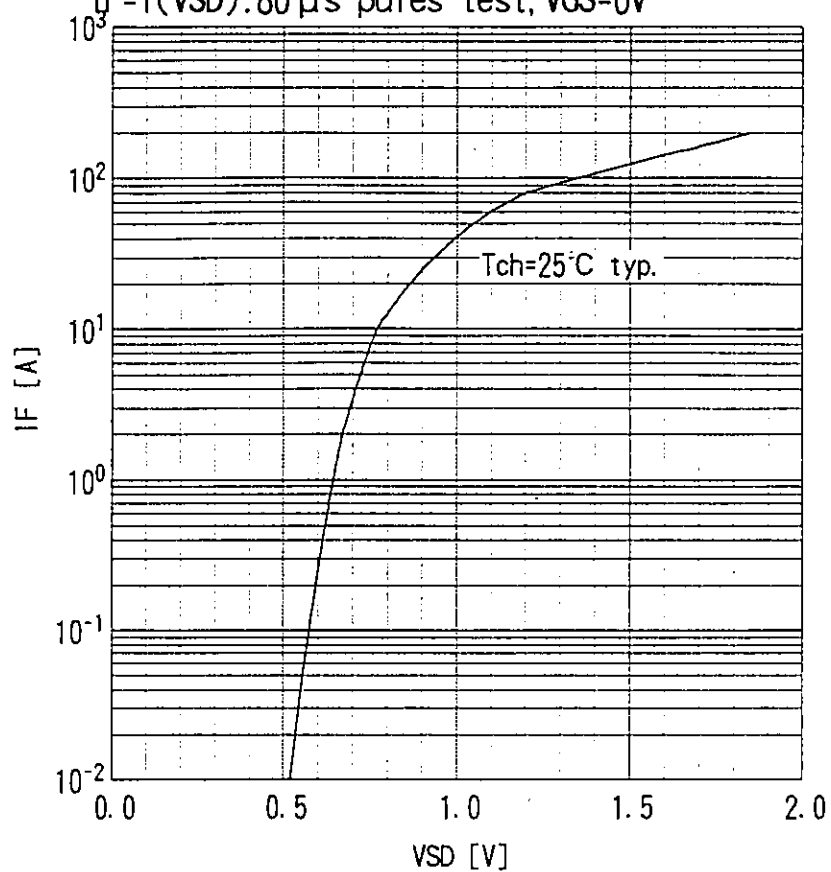
Typical capacitances

$C=f(V_{DS}): V_{GS}=0V, f=1MHz$



Forward characteristic of reverse of diode

$I_F = f(V_{SD})$: 80 μ s pules test, $V_{GS} = 0V$



Transient thermal impedande

$Z_{thch} = f(t)$ parameter: $D = t/T$

